

Material	Dual e-Beam	Thermal e-Beam	Sputterer	PLD	Supplied by
Aluminum	X	X	X		UDNF
Aluminum Oxide	X	X	X		UDNF
Bismuth and Gallium Substituted Thulium Iron Garnet (Tm _{2.5} Bi _{0.5} Fe _{3.8} Ga _{1.2} O ₁₂)				X	User
Bismuth and Gallium Substituted Thulium Iron Garnet (Tm _{2.7} Bi _{0.3} Fe _{4.5} Ga _{0.5} O ₁₂)				X	User
Boron 10 (B10) >95%			X		User
Boron		X			User
Boron Carbide			X		User
Chromium	X	X	X		UDNF
Cobalt	X	X	X		UDNF
Cobalt/iron 90/10		X			UDNF
Cobalt/Iron/boron 60/20/20 % at 99.95%			X		UDNF
Copper	X	X	X		UDNF
Gallium Oxide/Bismuth Oxide				X	User
Germanium	X	X	X		Sputterer Target by User
Gold	X	X			UDNF
Iron		X	X		UDNF
Mo		X			User
MgO		X			User
Nickel	X	X	X		UDNF

Nickel/Iron 81/19	X	X	X		UDNF
Palladium	X	X			UDNF
Platinum	X	X	X		UDNF
Ruthenium	X	X			UDNF
Scandium			X		User
Silicon, p-type	X	X			UDNF
Silicon Carbide			X		UDNF
Silicon Nitride			X		User
Silicon monoxide		X			User
Silicon Dioxide	X	X	X		UDNF
Silver	X	X			UDNF
Tantalum	X	X			UDNF
Terbium Iron Garnet ($Tb_3Fe_5O_{12}$)				X	User
Thulium Iron Garnet ($Tm_3Fe_5O_{12}$)				X	User
Tin Oxide			X		UDNF
Titanium	X	X	X		UDNF
Titanium Oxide	X	X	X		UDNF
Tungsten			X		UDNF
Tungsten Oxide	X	X			UDNF
Vanadium Pentoxide				X	User
Vanadium pentoxide/Tungsten Dioxide				X	User
Yttrium Iron Oxide (YIG)			X	X	UDNF

Last Updated

April 13, 2023